

06-26-2000



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To the Honorable Commissioner of F 101389977 Attached original document or copy thereof.

1. Names of conveying parties:

- 1) PAOLO CASATI
- 2) CARLO COGNETTI
- 3) \_\_\_\_\_
- 4) \_\_\_\_\_
- 5) \_\_\_\_\_
- 6) \_\_\_\_\_

MKD  
6.15.0



Additional names of conveying parties attached?  Yes  No

2. Name and address of receiving party:

Name: STMICROELECTRONICS, S.r.l.

Internal Address: \_\_\_\_\_

Street Address: VIA C. OLIVETTI, 2

Postal Code & City: I-20041 AGRATE BRIANZA

Country ITALY

Additional names & addresses attached?  Yes  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

Execution Dates:

- 1) MARCH 30, 2000 4) \_\_\_\_\_
- 2) APRIL 4, 2000 5) \_\_\_\_\_
- 3) \_\_\_\_\_ 6) \_\_\_\_\_

4. Application number(s) or registration number(s):

If this document is being filed together with a new application,  
the execution date of the application is \_\_\_\_\_

A. Patent Application No(s).  
09/507,558

B. Patent No(s).

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: SEED INTELLECTUAL PROPERTY LAW GROUP PLLC

Internal Address: ROBERT IANNUCCI

Street Address: 701 FIFTH AVENUE, SUITE 6300

City: SEATTLE State: WA ZIP: 98104-7092

6. Total number of applications and patents involved..... 1

7. Total Fee (37 CFR 3.41): ..... \$40

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

19-1090

06/22/2000 YPOLITE1 00000015 09507558

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40.00 DP

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

E. RUSSELL TARLETON

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and document: 3

## ASSIGNMENT

WHEREAS, we, Paolo CASATI and Carlo COGNETTI (hereinafter referred to as ASSIGNORS), having post office addresses of Via Fermi, 19, I-20099 Sesto S. Giovanni (Milano), Italy, and Viale Ranzoni, 1, I-20149 Milano, Italy, respectively, are the joint inventors of an invention entitled "INSULATED POWER MULTICHIP PACKAGE," as described and claimed in the specification forming part of an application for United States letters patent filed with the United States Patent and Trademark Office on February 18, 2000 and having an application number 09/507,558.

WHEREAS, STMicroelectronics S.r.l. (hereinafter referred to as ASSIGNEE), a corporation of the country of Italy having a place of business at Via C. Olivetti, 2, I-20041 Agrate Brianza (Milano), Italy, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all countries of the world;

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all countries of the world, and in any and all divisions, reissues and continuations thereof, including the right to file applications worldwide directly in the name of ASSIGNEE and to claim priority rights deriving from the first filed application to which said worldwide applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had ASSIGNORS been the original owners and this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and letters patent in all countries of the world on said invention, for litigation regarding letters patent, or for the purpose of protecting title to said invention or letters patent therefor.



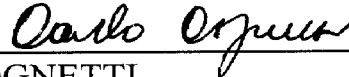
Paolo CASATI

Date: 30-03-00

I certify that I know or have satisfactory evidence that the above person signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

Witness \_\_\_\_\_

Date: \_\_\_\_\_



Carlo COGNETTI

Date: 4/4/00

I certify that I know or have satisfactory evidence that the above person signed this instrument of his/her own free will, as a voluntary act for the uses and purposes mentioned in the instrument.

Witness \_\_\_\_\_

Date: \_\_\_\_\_